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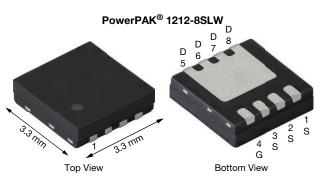
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RoHS

COMPLIANT HALOGEN

FREE

Automotive N-Channel 40 V (D-S) 175 °C MOSFET

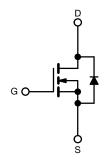


Marking code: Q050

PRODUCT SUMMARY			
V _{DS} (V)	40		
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.0065		
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0045		
I _D (A) ^e	86		
Configuration	Single		

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK [®] 1212-8SLW
Lead (Pb)-free and halogen-free	SQS142ELNW (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40		
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current ^e	T _C = 25 °C		86		
	T _C = 125 °C	ID	63		
Continuous source current (diode conduction) e		I _S	64	А	
Pulsed drain current ^{a, e}	ed drain current ^{a, e}		271		
Single pulse avalanche current		I _{AS}	22.5		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	25.3	mJ	
	T _C = 25 °C	D	70	14/	
Maximum power dissipation ^a	T _C = 125 °C	P _D	23	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260	-0	
THERMAL RESISTANCE RATIN	GS				
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	P R _{thJA} 54		80 AA	
Junction-to-case (drain) d	ż	R _{th.IC}	2.1	°C/W	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (www.vishav.com/doc?73257). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. As per on JESD51-14

e. Values based on RthJC and TC 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

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For technical questions, contact: automostechsupport@vishay.com

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	1.2	1.7	2.5	V
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	μA
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	-	-	150	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	20	-	-	Α
		V _{GS} = 4.5 V	I _D = 10 A	-	0.0050	0.0065	-
	_	V _{GS} = 10 V		-	0.0034	0.0045	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.0078	Ω
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.0095	1
Forward transconductance ^b	g _{fs}	V _{DS}	= 15 V, I _D = 10 A	-	70	-	S
Dynamic ^b					I		
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 25 V, f = 1 MHz	-	1744	2442	pF
Output capacitance	C _{oss}			-	442	619	
Reverse transfer capacitance	C _{rss}			-	39	55	
Total gate charge ^c	Qg			-	32	48	
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V V _{DS} = 20 V, I _D = 3 A	-	6	-	nC	
Gate-drain charge ^c	Q _{gd}				6		-
Gate resistance	R _g		f = 1 MHz	0.7	1.4	2.1	Ω
Turn-on delay time ^c	t _{d(on)}			-	11	17	
Rise time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, R_{\text{L}} = 6.67 \; \Omega \\ I_{\text{D}} \cong 3 \; \text{A}, V_{\text{GEN}} = 10 \; \text{V}, R_{\text{g}} = 1 \; \Omega \end{array}$		-	4	8	1
Turn-off delay time ^c	t _{d(off)}			-	25	38	ns
Fall time ^c	t _f			-	6	9	
Source-Drain Diode Ratings and Charac	teristic ^b					I	
Pulsed current ^a	I _{SM}			-	-	271	A
Forward voltage	V _{SD}	I _F =	10 A, V _{GS} = 0 V	-	0.82	1.1	V
Body diode reverse recovery time	t _{rr}	$V_{DD} = 32$ V, I _{FM} = 3 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	27	54	ns
Body diode reverse recovery charge	Q _{rr}			-	19	38	nC
Reverse recovery fall time	ta			-	14	-	<u> </u>
Reverse recovery rise time	t _b			-	14	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			_	-1.2	_	A

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

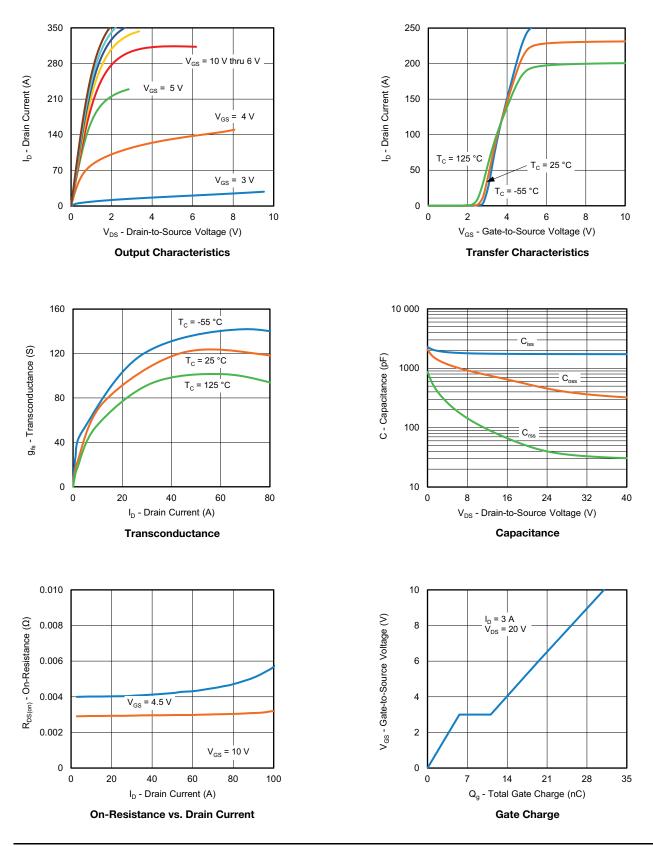
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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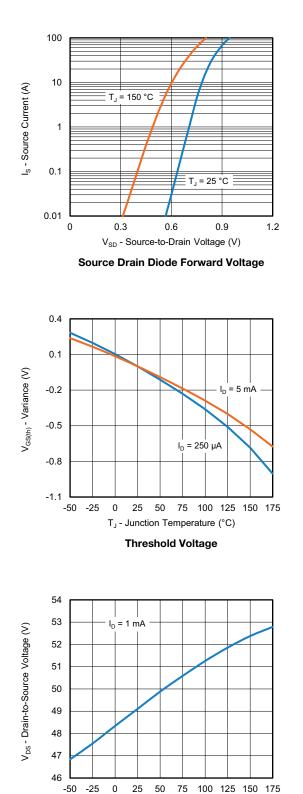
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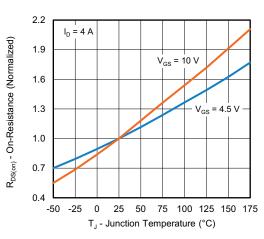
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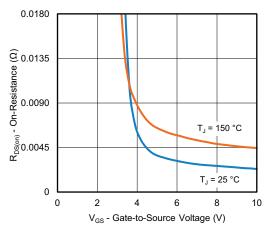
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

T_J - Junction Temperature (°C) Drain Source Breakdown vs. Junction Temperature

50

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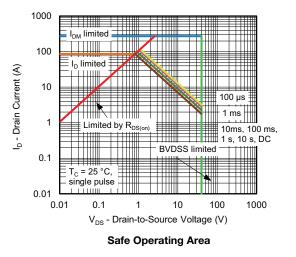
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



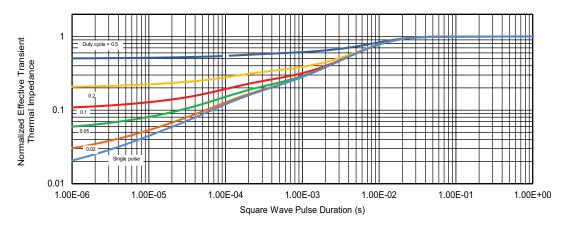
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

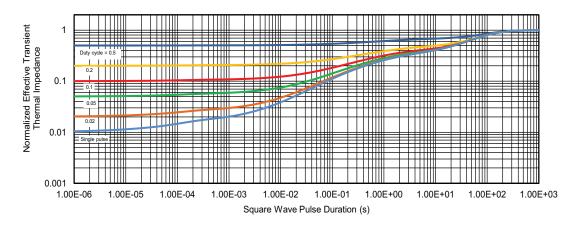


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case





Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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